





P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
	90mΩ @ V _{GS} = -10V	-3.8A
-30V	134mΩ @ V _{GS} = -4.5V	-3.1A

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 standards for High Reliability

Description and Applications

This MOSFET has been designed to minimize the on-state resistance $(R_{DS(on)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

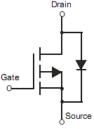
- General Purpose Interfacing Switch
- Power Management Functions
- Load Switch for Portable Devices

Mechanical Data

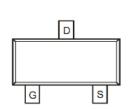
- Case: SOT-23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe.
 Solderable per MIL-STD-202, Method 208
- Weight: 0.08 grams (approximate)







Internal Schematic



TOP VIEW

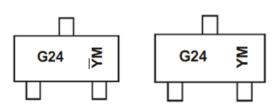
Ordering Information (Notes 4 & 5)

Ī	Part Number	Compliance	Case	Packaging
ı	DMG2307L-7	Standard	SOT-23	3000Tape & Reel
	DMG2307LQ-7	Automotive	SOT-23	3000Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



G24 = Product Type Marking Code

YM = Date Code Marking for SAT (Shanghai Assembly/ Test site)
YM = Date Code Marking for CAT (Chengdu Assembly/ Test site)
Y or Y = Year (ex: A = 2013)

M = Month (ex: 9 = September)

Chengdu A/T Site

Shanghai A/T Site

Date Code Key

Year	2009	2010	20	11	2012	2013	2014	2015	20	16	2017	2018
Code	W	Х	,	Y	Z	Α	В	С])	Е	F
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Drain-Source Voltage		V_{DSS}	-30	V	
Gate-Source Voltage			V_{GSS}	±20	V
Continuous Drain Current (Note 6) V _{GS} = -10V	Steady State	T _A = +25°C T _A = +70°C	I _D	-2.5 -2.0	Α
Continuous Drain Current (Note 7) V _{GS} = -10V	Steady State	T _A = +25°C T _A = +70°C	I _D	-3.8 -3.0	Α
Continuous Drain Current (Note 7) V _{GS} = -10V	t ≦10sec	$T_A = +25$ °C $T_A = +70$ °C	I _D	-4.6 -3.6	А
Continuous Drain Current (Note 7) V _{GS} = -4.5V	Steady State	T _A = +25°C T _A = +70°C	I _D	-3.1 -2.5	Α
Pulsed Drain Current (Note 7)			I _{DM}	-20	Α

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 6)	P_{D}	0.76	W
Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	159	°C/W
Total Power Dissipation (Note 7)	P _D	1.36	W
Thermal Resistance, Junction to Ambient (Note 7)	$R_{\theta JA}$	94	°C/W
Total Power Dissipation (Note 7) $t \le 10$ sec	P _D	1.9	W
Thermal Resistance, Junction to Ambient (Note 7) t ≤ 10sec	$R_{\theta JA}$	65.8	°C/W
Operating and Storage Temperature Range	$T_{J_{i}}T_{STG}$	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage		BV _{DSS}	-30	_	-	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current @T _C =	= +25°C	I _{DSS}	_	-	-1.0	μA	$V_{DS} = -30V, V_{GS} = 0V$
Gate-Source Leakage		I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage		V _{GS(th)}	-1.0	_	-3.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Static Drain-Source On-Resistance			_	70	90	mΩ	$V_{GS} = -10V, I_D = -2.5A$
Static Drain-Source On-Resistance		R _{DS (ON)}	ı	105	134	11122	$V_{GS} = -4.5V$, $I_D = -2.5A$
Forward Transfer Admittance		Y _{fs}	ı	4.8	_	S	$V_{DS} = -10V, I_D = -2.5A$
Diode Forward Voltage (Note 7)		V_{SD}	_	-0.75	-1.0	V	$V_{GS} = 0V, I_{S} = -1A$
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	out Capacitance		ı	371.3	-	pF	45)/)/
Output Capacitance		Coss	_	51.3	_	pF	V _{DS} = -15V, V _{GS} = 0V, -f = 1.0MHz
Reverse Transfer Capacitance		C _{rss}	ı	45.9	_	pF	1 = 1.0iviriz
Gate Resistance		R_g	-	17	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (V _{GS} = -4.5V)		Q_{g}	ı	4.0	_	nC	
Total Gate Charge (V _{GS} = -10V)		Qg	-	8.2	_	nC	$V_{GS} = -10V, V_{DS} = -15V,$
Gate-Source Charge		Q_{gs}	1	0.9	_	nC	I _D = -3A
Gate-Drain Charge		Q_{qd}	-	1.2	_	nC	1
Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time		t _{D(on)}	_	4.8	_	ns	4514.14
		t _r	1	7.3	_	ns	$V_{DS} = -15V, V_{GS} = -10V,$
		t _{D(off)}	1	22.4	_	ns	$R_L = 15\Omega$, $R_G = 6\Omega$,
Turn-Off Fall Time		t _f	-	13.4	_	ns	I _D = -1A

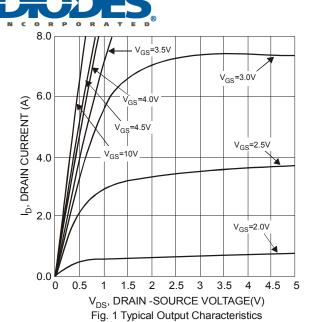
Notes: 6. Device mounted on FR-4 PCB, with minimum recommended pad layout.

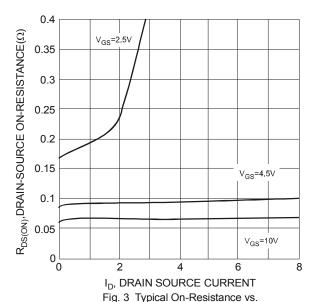
^{7.} Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1inch square copper plate.

^{8.} Short duration pulse test used to minimize self-heating effect.

^{9.} Guaranteed by design. Not subject to product testing.







Drain Current and Gate Voltage

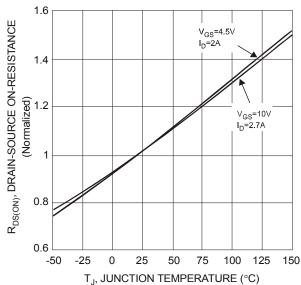
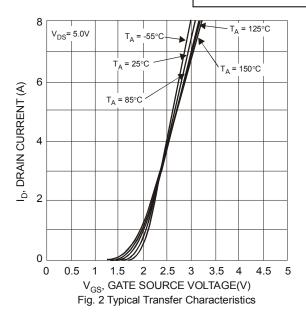
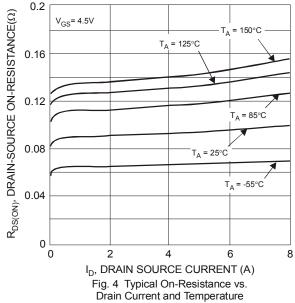


Fig. 5 On-Resistance Variation with Temperature





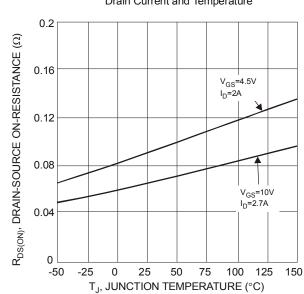


Fig. 6 On-Resistance Variation with Temperature



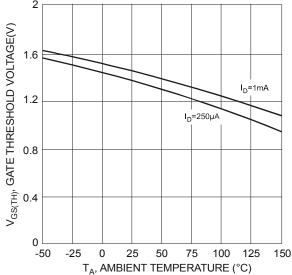
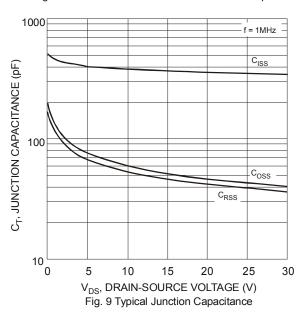
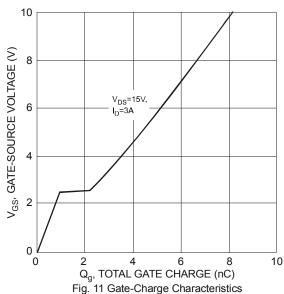
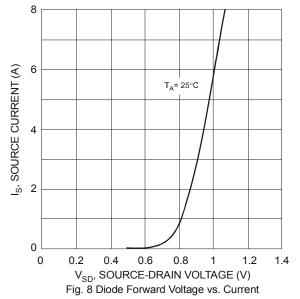


Fig. 7 Gate Threshold Variation vs. Ambient Temperature







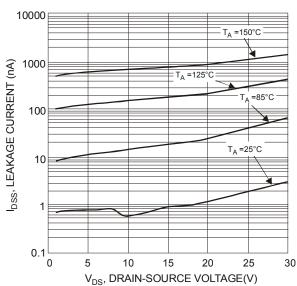
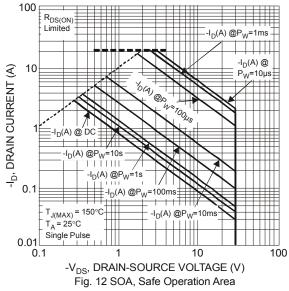
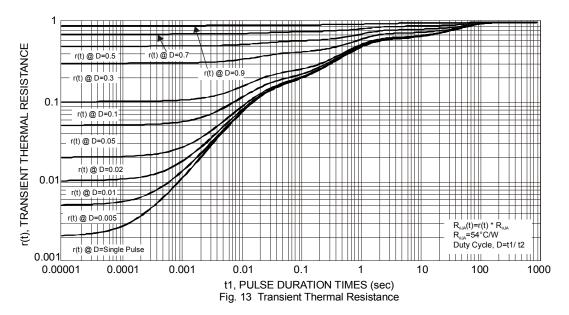


Fig. 10 Typical Drain-Source Leakage Current vs. Voltage

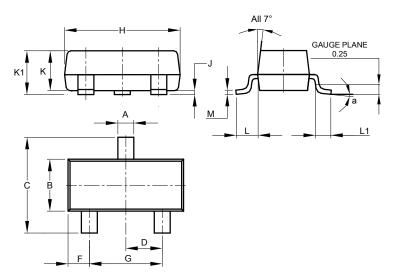






Package Outline Dimensions

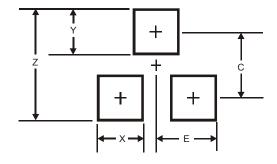
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT23								
Dim	Min	Max	Тур					
Α	0.37	0.51	0.40					
В	1.20	1.40	1.30					
С	2.30	2.50	2.40					
D	0.89	1.03	0.915					
F	0.45	0.60	0.535					
G	1.78	2.05	1.83					
Н	2.80	3.00	2.90					
J	0.013	0.10	0.05					
K	0.890	1.00	0.975					
K1	0.903	1.10	1.025					
L	0.45	0.61	0.55					
L1	0.25	0.55	0.40					
M	0.085	0.150	0.110					
α	α 8°							
All Dimensions in mm								

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.9
X	0.8
Y	0.9
С	2.0
Е	1.35



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